STW56N65M2-4



N-channel 650 V, 0.049 Ω typ., 49 A MDmesh™ M2 Power MOSFET in a TO247-4 package

Datasheet - production data

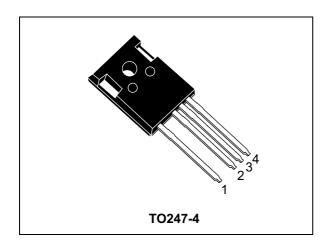
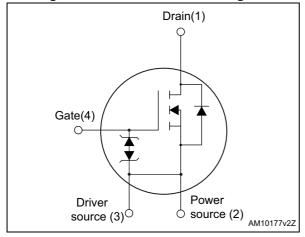


Figure 1. Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max	I _D
STW56N65M2-4	650 V	0.062 Ω	49 A

- Excellent switching performance thanks to the extra driving source pin
- · Extremely low gate charge
- Excellent output capacitance (Coss) profile
- 100% avalanche tested
- Zener-protected

Applications

· Switching applications

Description

This device is an N-channel Power MOSFET developed using MDmesh™ M2 technology. Thanks to its strip layout and an improved vertical structure, the device exhibits low on-resistance and optimized switching characteristics, rendering it suitable for the most demanding high efficiency converters.

Table 1. Device summary

Order code	Marking	Package	Packaging
STW56N65M2-4	56N65M2	TO247-4	Tube

Contents STW56N65M2

Contents

1	Electrical ratings3
2	Electrical characteristics4
	2.1 Electrical characteristics (curves)
3	Test circuits
4	Package mechanical data
	4.1 TO247-4, STW56N65M2-4
5	Revision history

STW56N65M2 Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{GS}	Gate- source voltage	±25	V
I _D	Drain current (continuous) at T _C = 25 °C	49	Α
I _D	Drain current (continuous) at T _C = 100 °C	31	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	196	Α
P _{TOT}	Total dissipation at T _C = 25 °C	358	W
dv/dt (2)	Peak diode recovery voltage slope	15	V/ns
dv/dt ⁽³⁾	MOSFET dv/dt ruggedness	50	V/ns
T _{stg}	Storage temperature	- 55 to 150	°C
T _j	Max. operating junction temperature	150	°C

^{1.} Pulse width limited by safe operating area

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{thj-amb}	Thermal resistance junction-ambient max	50	°C/W
R _{thj-case}	Thermal resistance junction-case max	0.35	°C/W

Table 4. Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR}	Max current during repetitive or single pulse avalanche (pulse width limited by T _{JMAX})	3.5	Α
E _{AS}	Single pulse avalanche energy (starting $T_j = 25$ °C, $I_D = I_{AR}$, $V_{DD} = 50$ V)	1300	mJ

^{2.} $I_{SD} \leq$ 49 A, di/dt = 400 A/ μ s, $V_{DS (peak)} < V_{(BR)DSS}$, $V_{DD} =$ 400 V

 $^{3. \}quad V_{DS} \leq 520 \ V$

Electrical characteristics STW56N65M2

2 Electrical characteristics

(T_C = 25 °C unless otherwise specified)

Table 5. On /off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	I _D = 1 mA, V _{GS} = 0	650			V
I _{DSS}	Zero gate voltage drain current (V _{GS} = 0)	V _{DS} = 650 V V _{DS} = 650 V, T _C = 125 °C			1 100	μA μA
I _{GSS}	Gate-body leakage current (V _{DS} = 0)	V _{GS} = ± 25 V			± 10	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2	3	4	V
R _{DS(on)}	Static drain-source on- resistance	V _{GS} = 10 V, I _D = 24.5 A		0.049	0.062	Ω

Table 6. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance		-	3900	-	pF
C _{oss}	Output capacitance	V _{DS} = 100 V, f = 1 MHz,	-	160	-	pF
C _{rss}	Reverse transfer capacitance	$V_{GS} = 0$	-	2.8	-	pF
C _{o(er)} ⁽¹⁾	Equivalent Output Capacitance	$V_{GS} = 0$, $V_{DS} = 0$ to 520 V	-	838	-	pF
R_{G}	Intrinsic gate resistance	f = 1 MHz open drain	-	4.6	-	Ω
Qg	Total gate charge		-	93	-	nC
Q _{gs}	Gate-source charge	$V_{DD} = 520 \text{ V}, I_D = 49 \text{ A},$ $V_{GS} = 10 \text{ V}, (see Figure 15)$	-	16	-	nC
Q_{gd}	Gate-drain charge	1.GS 1.5 1, (2.50 7 1gano 1.0)	-	40	-	nC

Coss eq. is defined as a constant equivalent capacitance giving the same charging time as Coss when VDS increases from 0 to 80% VDSS

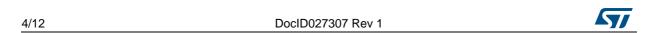


Table 7. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	V _{DD} = 325 V, I _D = 24.5 A,	-	19	-	ns
t _r	Rise time	$R_G = 4.7 \Omega, V_{GS} = 10 V$	-	27.5	-	ns
t _{d(off)}	Turn-off delay time	(see Figure 16 and	-	146	-	ns
t _f	Fall time	Figure 19)	-	13	-	ns

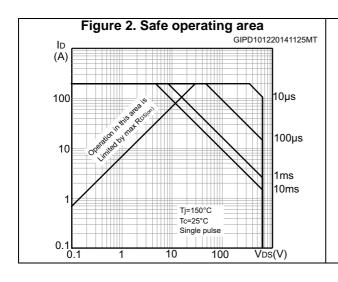
Table 8. Source drain diode

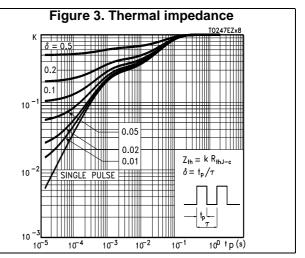
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		49	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		196	Α
V _{SD} (2)	Forward on voltage	I _{SD} = 49 A, V _{GS} = 0	-		1.6	V
t _{rr}	Reverse recovery time	I _{SD} = 49 A,	-	554		ns
Q_{rr}	Reverse recovery charge	di/dt = 100 A/μs	-	13.5		μC
I _{RRM}	Reverse recovery current	V _{DD} = 60 V (see <i>Figure 16</i>)	-	49.5		Α
t _{rr}	Reverse recovery time	I _{SD} = 49 A,	-	688		ns
Q _{rr}	Reverse recovery charge	di/dt = 100 A/µs	-	18		μC
I _{RRM}	Reverse recovery current	$V_{DD} = 60 \text{ V, T}_{j} = 150 \text{ °C}$ (see <i>Figure 19</i>)	-	52		Α

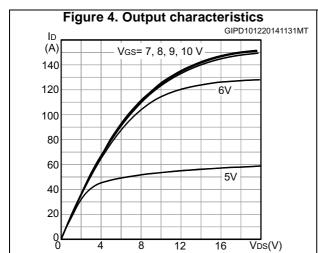
^{1.} Pulse width limited by safe operating area

^{2.} Pulsed: pulse duration = 300 µs, duty cycle 1.5%

2.1 Electrical characteristics (curves)







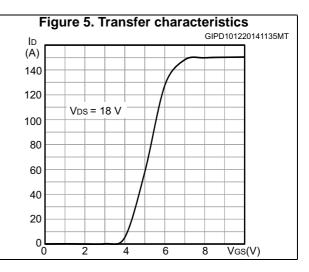
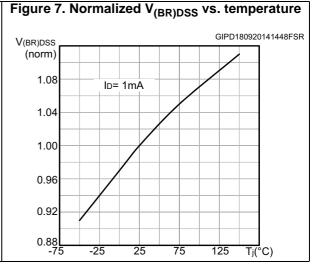
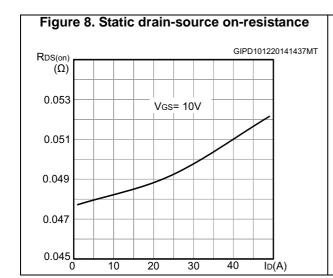
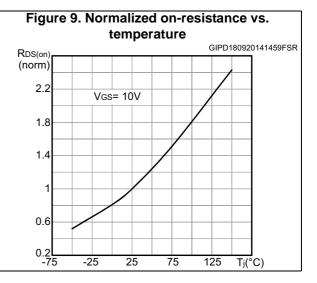
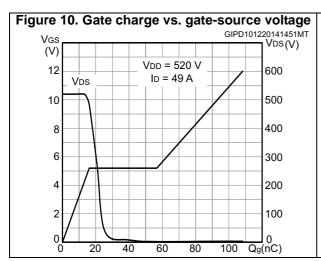


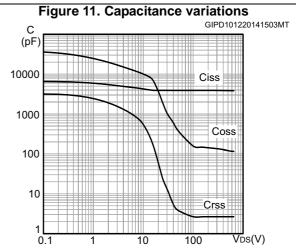
Figure 6. Normalized gate threshold voltage vs. temperature GIPD180920141442FSR Vgs(th)(norm) $ID = 250 \mu A$ 1.1 1.0 0.9 8.0 0.7 -25 75 125 25 Tj(°C)

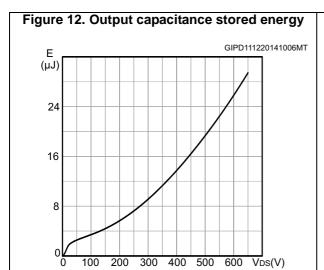


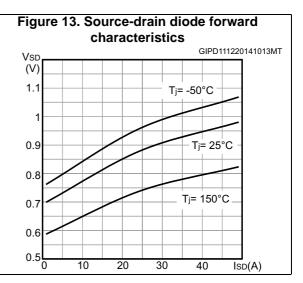






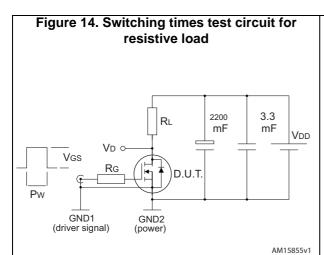


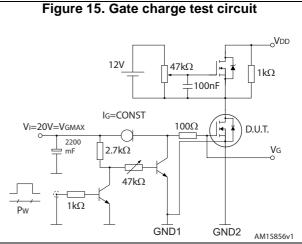


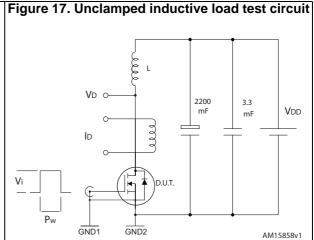


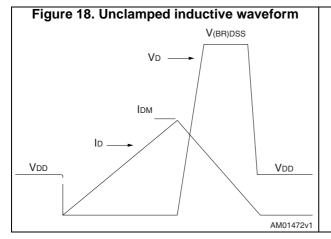
Test circuits STW56N65M2

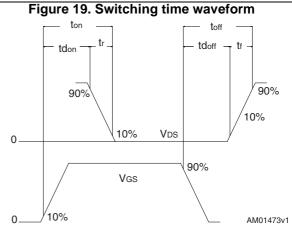
3 Test circuits











Package mechanical data 4

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TO247-4, STW56N65M2-4 4.1

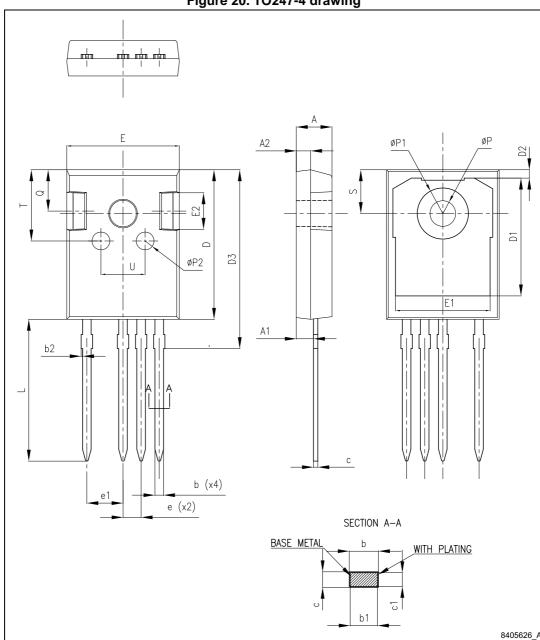


Figure 20. TO247-4 drawing

Table 9. TO247-4 mechanical data

Dim		mm.	
Dim.	Min.	Тур.	Max.
А	4.90	5.00	5.10
A1	2.31	2.41	2.51
A2	1.90	2.00	2.10
b	1.16		1.29
b1	1.15	1.20	1.25
b2	0		0.20
С	0.59		0.66
c1	0.58	0.60	0.62
D	20.90	21.00	21.10
D1	16.25	16.55	16.85
D2	1.05	1.20	1.35
D3	24.97	24.97 25.12 25	
E	15.70	15.80	15.90
E1	13.10 13.30		13.50
E2	4.90 5.00		5.10
E3	2.40	2.50	2.60
е	2.44	2.54	2.64
e1	4.98	5.08	5.18
L	19.80	19.92	20.10
Р	3.50	3.60	3.70
P1			7.40
P2	2.40	2.50	2.60
Q	5.60		6.00
S		6.15	
Т	9.80		10.20
U	6.00		6.40

STW56N65M2 Revision history

5 Revision history

Table 10. Document revision history

Date	Revision	Changes
15-Dec-2014	1	Initial release.

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